

PATENT APPLICATION

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Docket No: Q84185

Kenji YAKUSHIJI, et al.

Group Art Unit: 2812

Confirmation No.: 9791

Examiner: Unknown

Filed: May 19, 2006

For: PRODUCTION METHOD FOR SEMICONDUCTOR DEVICE

REQUEST FOR CORRECTED OFFICIAL FILING RECEIPT

ATTN: Office of Initial Patent Examination

Filing Receipt Correction

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

Sir:

We enclose a copy of the Official Filing Receipt for the above-identified application and request the following correction:

Assignment for Published Patent Application

~~SHOWA DENKO K.K., Tokyo, JAPAN~~
SHOWA DENKO K.K.

Verification for the requested correction is indicated on the Executed Assignment Document filed May 19, 2006.

Respectfully submitted,



Abraham J. Rosner

Registration No. 33,276

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WASHINGTON OFFICE

CUSTOMER NUMBER

23373

Date: April 30, 2007

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UNITED STATES PATENT AND TRADEMARK OFFICE

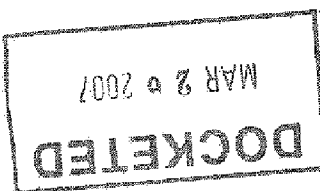
APPL NO.	10/580,107	FILING OR 371(c) DATE	05/19/2006	ART UNIT	2812	FIL FEE REC'D	1300	ATTY DOCKET NO	Q84185	TOT CLMS	20	IND CLMS	5
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CONFIRMATION NO. 9791

FILING RECEIPT



0C000000023004069



23373
 SUGHRUE MION, PLLC
 2100 PENNSYLVANIA AVENUE, N.W.
 SUITE 800
 WASHINGTON, DC 20037

Date Mailed: 03/22/2007

Receipt is acknowledged of this regular Patent Application. It will be considered in its order and you will be notified as to the results of the examination. Be sure to provide the U.S. APPLICATION NUMBER, FILING DATE, NAME OF APPLICANT, and TITLE OF INVENTION when inquiring about this application. Fees transmitted by check or draft are subject to collection. Please verify the accuracy of the data presented on this receipt. If an error is noted on this Filing Receipt, please mail to the Commissioner for Patents P.O. Box 1450 Alexandria Va 22313-1450. Please provide a copy of this Filing Receipt with the changes noted thereon. If you received a "Notice to File Missing Parts" for this application, please submit any corrections to this Filing Receipt with your reply to the Notice. When the USPTO processes the reply to the Notice, the USPTO will generate another Filing Receipt incorporating the requested corrections (if appropriate).

Applicant(s)

Kenji Yakushiji, Chiba, JAPAN;
 Katsuki Kusunoki, Chiba, JAPAN;
 Hisayuki Miki, Chiba, JAPAN;

Assignment For Published Patent Application

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Power of Attorney: The patent practitioners associated with Customer Number 23373.

Domestic Priority data as claimed by applicant

This application is a 371 of PCT/JP05/18731 10/05/2005
 which claims benefit of 60/618,583 10/15/2004

Foreign Applications

JAPAN 2004-294934 10/07/2004

If Required, Foreign Filing License Granted: 03/20/2007

The country code and number of your priority application, to be used for filing abroad under the Paris Convention, is US10/580,107

Projected Publication Date: 06/28/2007

U.S. ASSIGNMENT

IN CONSIDERATION of the sum of One Dollar (\$1.00), and of other good and valuable consideration paid to the undersigned inventor(s) (hereinafter "ASSIGNOR") by

SHOWA DENKO K.K.,

13-9, Shibadainon 1-chome, Minato-ku, Tokyo 105-8518, Japan

(Insert
ASSIGNEE'S
Name(s)
Address(es))

(Hereinafter "ASSIGNEE"), the receipt of which is hereby acknowledged, the undersigned ASSIGNOR hereby sells, assigns and transfers to ASSIGNEE the entire and exclusive right, title and interest in the invention entitled

PRODUCTION METHOD FOR SEMICONDUCTOR DEVICE

(Title of
Invention)

relating to International Patent Application PCT/JP2005/018731 and/or for which application for Letters Patent of the United States was executed on even date herewith or, if not so executed, was:

(a) executed on _____
(b) filed on _____
Serial No. _____

(Insert date
of execution
of application,
if not
concurrent)

_____ is hereby authorized to insert in (b) the specified data, when known.

and to said application and all Letters Patent(s) of the United States granted on said application and any continuation, division, renewal, substitute, reissue or examination application based thereon, for the full term or terms for which the said Letters Patent(s) may be granted and including any extensions thereof (collectively, hereinafter, "said application(s) and Letters Patent(s)").

The ASSIGNOR agree(s), when requested by said ASSIGNEE and without charge to but at the expense of said ASSIGNEE, to do all acts which the ASSIGNEE may deem necessary, desirable or expedient, for securing, maintaining and enforcing protection for said invention, including in the preparation and prosecution of said application(s) and the issuance of said Letters Patent(s), in any interference, reexamination, or public use proceeding, and in any litigation or other legal proceeding which may arise or be declared in relation to same, such acts to include but not be limited to securing all proper, including separate assignments and declarations, taking all rightful oaths, providing sworn testimony, and obtaining and producing evidence.

IN WITNESS WHEREOF, the undersigned inventor(s) has (have) affixed his/her/their signature(s).

(Signature) _____
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April 18, 2006
(TYPE NAME) (DATE)
(Signature) _____
Katsuki Kasunoki
April 18, 2006
(TYPE NAME) (DATE)
(Signature) _____
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April 18, 2006
(TYPE NAME) (DATE)

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